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Details

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Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	40MHz
Connectivity	I ² C, IrDA, LINbus, PMP, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I ² S, POR, PWM, WDT
Number of I/O	33
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 13x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VQFN Exposed Pad
Supplier Device Package	44-QFN (8x8)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx220f032d-v-ml

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

TABLE 10: PIN NAMES FOR 44-PIN USB DEVICES

44-PIN QFN (TOP VIEW)^(1,2,3,5)

PIC32MX210F016D PIC32MX220F032D PIC32MX230F064D PIC32MX230F256D PIC32MX250F128D PIC32MX270F256D

			44 1
Pin #	Full Pin Name	Pin #	Full Pin Name
1	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2
2	RPC6/PMA1/RC6	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2
6	Vss	28	VDD
7	VCAP	29	Vss
8	PGED2/RPB10/D+/CTED11/RB10	30	OSC1/CLKI/RPA2/RA2
9	PGEC2/RPB11/D-/RB11	31	OSC2/CLKO/RPA3/RA3
10	VUSB3V3	32	TDO/RPA8/PMA8/RA8
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4
12	PGED4/TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4
13	PGEC4/TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9
14	CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14	36	AN12/RPC3/RC3
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4
16	AVss	38	RPC5/PMA3/RC5
17	AVdd	39	Vss
18	MCLR	40	VDD
19	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0	41	RPB5/USBID/RB5
20	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1	42	VBUS
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7
22	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1	44	RPB8/SCL1/CTED10/PMD4/RB8

Note 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

4: This pin function is not available on PIC32MX110F016D and PIC32MX120F032D devices.

5: Shaded pins are 5V tolerant.

		Pin Nu	mber ⁽¹⁾				
Pin Name	28-pin QFN	28-pin SSOP/ SPDIP/ SOIC	36-pin VTLA	44-pin QFN/ TQFP/ VTLA	Pin Type	Buffer Type	Description
OC1	PPS	PPS	PPS	PPS	0	_	Output Compare Output 1
OC2	PPS	PPS	PPS	PPS	0	—	Output Compare Output 2
OC3	PPS	PPS	PPS	PPS	0	—	Output Compare Output 3
OC4	PPS	PPS	PPS	PPS	0	—	Output Compare Output 4
OC5	PPS	PPS	PPS	PPS	0	—	Output Compare Output 5
OCFA	PPS	PPS	PPS	PPS	I	ST	Output Compare Fault A Input
OCFB	PPS	PPS	PPS	PPS	I	ST	Output Compare Fault B Input
INT0	13	16	17	43	I	ST	External Interrupt 0
INT1	PPS	PPS	PPS	PPS	I	ST	External Interrupt 1
INT2	PPS	PPS	PPS	PPS	I	ST	External Interrupt 2
INT3	PPS	PPS	PPS	PPS	I	ST	External Interrupt 3
INT4	PPS	PPS	PPS	PPS	I	ST	External Interrupt 4
RA0	27	2	33	19	I/O	ST	PORTA is a bidirectional I/O port
RA1	28	3	34	20	I/O	ST	1
RA2	6	9	7	30	I/O	ST	1
RA3	7	10	8	31	I/O	ST	1
RA4	9	12	10	34	I/O	ST	1
RA7	_	_	_	13	I/O	ST	1
RA8	_	_	_	32	I/O	ST	
RA9	_	_	_	35	I/O	ST	1
RA10	_	_	_	12	I/O	ST	
RB0	1	4	35	21	I/O	ST	PORTB is a bidirectional I/O port
RB1	2	5	36	22	I/O	ST	7
RB2	3	6	1	23	I/O	ST	7
RB3	4	7	2	24	I/O	ST	
RB4	8	11	9	33	I/O	ST	
RB5	11	14	15	41	I/O	ST	
RB6	12 ⁽²⁾	15 (2)	16 (2)	42 ⁽²⁾	I/O	ST	
RB7	13	16	17	43	I/O	ST	
RB8	14	17	18	44	I/O	ST	
RB9	15	18	19	1	I/O	ST	
RB10	18	21	24	8	I/O	ST	
RB11	19	22	25	9	I/O	ST	
RB12	20 ⁽²⁾	23 ⁽²⁾	26 ⁽²⁾	10 ⁽²⁾	I/O	ST	1
RB13	21	24	27	11	I/O	ST	1
RB14	22	25	28	14	I/O	ST	1
RB15	23	26	29	15	I/O	ST	
Legend:	CMOS = CN	MOS compa	atible input	or output		Analog =	Analog input P = Power
	SI = Schmi	tt Irigger in	put with CN	VIOS levels		O = Outp	out I = Input
Note 1.			lod for rofo	ronco only	See the	"Pin Diag	$m_{\text{rem}} = N/A$

DINOUT I/O DESCRIPTIONS (CONTINUED)

2: Pin number for PIC32MX1XX devices only.

3: Pin number for PIC32MX2XX devices only.

2.9 Typical Application Connection Examples

Examples of typical application connections are shown in Figure 2-5 and Figure 2-6.





FIGURE 2-6: AUDIO PLAYBACK APPLICATION



4.2 Bus Matrix Control Registers

TABLE 4-2: BUS MATRIX REGISTER MAP

ess)		ø										Bits							
Virtual Addr (BF88_#	Register Name	Bit Rang	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
2000		31:16	_		_	_	_	_		_	_	_	_	BMXERRIXI	BMXERRICD	BMXERRDMA	BMXERRDS	BMXERRIS	001F
2000	BINIXCON	15:0		_	_	_	_	-		—	_	BMXWSDRM	_	_	—	BI	MXARB<2:0>		0041
2010 BN		31:16	_		_		_	_		_	_	_	_	_	—	_	_	_	0000
	DIVIADAPDA'	15:0									BN	IXDKPBA<15:0>	>						0000
2020 E		31:16	_					_		—	_	—	—	_	—		_		0000
	BINIADODBA	15:0		BMXDUDBA<15:0> 0000															
2030		31:16	—	_	_		_	—	_	—	—	—	—	—	—	—	—	-	0000
2000		15:0									BN	IXDUPBA<15:0>	>						0000
2040	BMXDRMS7	31:16		RMYDRMS7<21:0>															
2040	DIVINDI (IVIOZ	15:0																	xxxx
2050		31:16	—	—	_			—	_	—	—		_	_		BMXPUPBA	<19:16>		0000
2000		15:0									BN	IXPUPBA<15:0>	>						0000
2060	BMYDEMS7	31:16									BM								xxxx
2000	DWXTTWOZ	15:0									DIV	IXI 1 WOZ < 01.02							xxxx
2070	BMXBOOTS7	31:16									BW	XBOOTS7<31-0							0000
2070	DWIXDOUTSZ	15:0									DIVI	NDOUT32531.0	~						0C00

Legend: x = unknown value on Reset; - = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: This register has corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

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REGISTER 8-1: OSCCON: OSCILLATOR CONTROL REGISTER

bit 3	CF: Clock Fail Detect bit
	1 = FSCM has detected a clock failure
	0 = No clock failure has been detected
bit 2	UFRCEN: USB FRC Clock Enable bit ⁽¹⁾
	 1 = Enable the FRC as the clock source for the USB clock source 0 = Use the Primary Oscillator or USB PLL as the USB clock source
bit 1	SOSCEN: Secondary Oscillator (Sosc) Enable bit
	1 = Enable the Secondary Oscillator
	0 = Disable the Secondary Oscillator
bit 0	OSWEN: Oscillator Switch Enable bit
	 1 = Initiate an oscillator switch to selection specified by NOSC<2:0> bits 0 = Oscillator switch is complete
Note 1:	This bit is only available on PIC32MX2XX devices.

Note: Writes to this register require an unlock sequence. Refer to Section 6. "Oscillator" (DS60001112) in the "PIC32 Family Reference Manual" for details.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0					
04.04	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
31:24	—		RODIV<14:8> ^(1,3)										
00.40	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0					
23:16	RODIV<7:0> ^(1,3)												
45.0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0, HC	R-0, HS, HC					
15:8	ON	_	SIDL	OE	RSLP ⁽²⁾	-	DIVSWEN	ACTIVE					
	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0					
7:0		_	_	_		ROSEL	<3:0>(1)						

REGISTER 8-3: REFOCON: REFERENCE OSCILLATOR CONTROL REGISTER

Legend:	HC = Hardware Clearable	HS = Hardware Settable			
R = Readable bit	W = Writable bit	U = Unimplemented bit, r	ead as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31 Unimplemented: Read as '0'

bit 30-16	RODIV<14:0> Reference Clock Divider bits ^(1,3)
	The value selects the reference clock divider bits. See Figure 8-1 for information.
bit 15	ON: Output Enable bit
	1 = Reference Oscillator module is enabled
	0 = Reference Oscillator module is disabled
bit 14	Unimplemented: Read as '0'
bit 13	SIDL: Peripheral Stop in Idle Mode bit

- 1 = Discontinue module operation when the device enters Idle mode
 - 0 =Continue module operation when the device enters lide mode
- bit 12 **OE:** Reference Clock Output Enable bit
 - 1 = Reference clock is driven out on REFCLKO pin
 - 0 = Reference clock is not driven out on REFCLKO pin
- bit 11 RSLP: Reference Oscillator Module Run in Sleep bit⁽²⁾
 - 1 = Reference Oscillator module output continues to run in Sleep
 - 0 = Reference Oscillator module output is disabled in Sleep
- bit 10 Unimplemented: Read as '0'
- bit 9 DIVSWEN: Divider Switch Enable bit
 - 1 = Divider switch is in progress
 - 0 = Divider switch is complete
- bit 8 ACTIVE: Reference Clock Request Status bit
 - 1 = Reference clock request is active
 - 0 = Reference clock request is not active
- bit 7-4 Unimplemented: Read as '0'
- **Note 1:** The ROSEL and RODIV bits should not be written while the ACTIVE bit is '1', as undefined behavior may result.
 - **2:** This bit is ignored when the ROSEL<3:0> bits = 0000 or 0001.
 - 3: While the ON bit is set to '1', writes to these bits do not take effect until the DIVSWEN bit is also set to '1'.

REGISTE	R 9-9: DCHxINT: DMA CHANNEL 'x' INTERRUPT CONTROL REGISTER (CONTINUED)
bit 4	CHDHIF: Channel Destination Half Full Interrupt Flag bit
	 1 = Channel Destination Pointer has reached midpoint of destination (CHDPTR = CHDSIZ/2) 0 = No interrupt is pending
bit 3	CHBCIF: Channel Block Transfer Complete Interrupt Flag bit
	 1 = A block transfer has been completed (the larger of CHSSIZ/CHDSIZ bytes has been transferred), or a pattern match event occurs 0 = No interrupt is pending
bit 2	CHCCIF: Channel Cell Transfer Complete Interrupt Flag bit
	1 = A cell transfer has been completed (CHCSIZ bytes have been transferred)0 = No interrupt is pending
bit 1	CHTAIF: Channel Transfer Abort Interrupt Flag bit
	 1 = An interrupt matching CHAIRQ has been detected and the DMA transfer has been aborted 0 = No interrupt is pending
bit 0	CHERIF: Channel Address Error Interrupt Flag bit
	 1 = A channel address error has been detected (either the source or the destination address is invalid) 0 = No interrupt is pending

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REGISTER 10-3: U1OTGSTAT: USB OTG STATUS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
51.24	—	—	—	—	—	—		—
22.16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	—	—	—	—	—	-	—
15.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.0	—	—	_	_	_	_		_
7:0	R-0	U-0	R-0	U-0	R-0	R-0	U-0	R-0
7.0	ID	_	LSTATE	_	SESVD	SESEND		VBUSVD

Legend:

Logonal			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

- bit 7 ID: ID Pin State Indicator bit
 - 1 = No cable is attached or a "type B" cable has been inserted into the USB receptacle
 - 0 = A "type A" OTG cable has been inserted into the USB receptacle
- bit 6 Unimplemented: Read as '0'
- bit 5 LSTATE: Line State Stable Indicator bit
 - 1 = USB line state (SE0 (U1CON<6>) bit and JSTATE (U1CON<7>)) bit has been stable for previous 1 ms 0 = USB line state (SE0 and JSTATE) has not been stable for previous 1 ms

bit 4 Unimplemented: Read as '0'

- bit 3 SESVD: Session Valid Indicator bit
 - 1 = VBUS voltage is above Session Valid on the A or B device
 - 0 = VBUS voltage is below Session Valid on the A or B device
- bit 2 SESEND: B-Device Session End Indicator bit
 - 1 = VBUS voltage is below Session Valid on the B device
 - 0 = VBUS voltage is above Session Valid on the B device

bit 1 Unimplemented: Read as '0'

- bit 0 VBUSVD: A-Device VBUS Valid Indicator bit
 - 1 = VBUS voltage is above Session Valid on the A device
 - 0 = VBUS voltage is below Session Valid on the A device

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
04.04	U-0	U-0						
31:24	—	—	—	—	—	—	—	—
22:16	U-0	U-0						
23:10	—	—	—	—	—	—	—	_
45.0	U-0	U-0						
15:8	—	—	—	—	—	—	—	—
	R/W-0	R/W-0						
7:0	BTSEE	BMYEE		BTOEE			CRC5EE ⁽¹⁾	DIDEE
	DIGLE	DIVIALL	DIVIALL	DIOLL	DINOLL	ONCIDEL	EOFEE ⁽²⁾	

REGISTER 10-9: U1EIE: USB ERROR INTERRUPT ENABLE REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

bit 7	BTSEE: Bit Stuff Error Interrupt Enable bit 1 = BTSEF interrupt is enabled 0 = BTSEF interrupt is disabled
bit 6	BMXEE: Bus Matrix Error Interrupt Enable bit
	1 = BMXEF interrupt is enabled0 = BMXEF interrupt is disabled
bit 5	DMAEE: DMA Error Interrupt Enable bit
	1 = DMAEF interrupt is enabled0 = DMAEF interrupt is disabled
bit 4	BTOEE: Bus Turnaround Time-out Error Interrupt Enable bit
	1 = BTOEF interrupt is enabled0 = BTOEF interrupt is disabled
bit 3	DFN8EE: Data Field Size Error Interrupt Enable bit
	1 = DFN8EF interrupt is enabled
	0 = DFN8EF interrupt is disabled

- bit 2 CRC16EE: CRC16 Failure Interrupt Enable bit
 - 1 = CRC16EF interrupt is enabled
 - 0 = CRC16EF interrupt is disabled
- bit 1 CRC5EE: CRC5 Host Error Interrupt Enable bit⁽¹⁾
 - 1 = CRC5EF interrupt is enabled
 - 0 = CRC5EF interrupt is disabled
 - EOFEE: EOF Error Interrupt Enable bit⁽²⁾
 - 1 = EOF interrupt is enabled
 - 0 = EOF interrupt is disabled
- bit 0 PIDEE: PID Check Failure Interrupt Enable bit
 - 1 = PIDEF interrupt is enabled
 - 0 = PIDEF interrupt is disabled
- Note 1: Device mode.
 - 2: Host mode.

Note: For an interrupt to propagate the USBIF register, the UERRIE (U1IE<1>) bit must be set.

11.3 Peripheral Pin Select

A major challenge in general purpose devices is providing the largest possible set of peripheral features while minimizing the conflict of features on I/O pins. The challenge is even greater on low pin-count devices. In an application where more than one peripheral needs to be assigned to a single pin, inconvenient workarounds in application code or a complete redesign may be the only option.

The Peripheral Pin Select (PPS) configuration provides an alternative to these choices by enabling peripheral set selection and their placement on a wide range of I/O pins. By increasing the pinout options available on a particular device, users can better tailor the device to their entire application, rather than trimming the application to fit the device.

The PPS configuration feature operates over a fixed subset of digital I/O pins. Users may independently map the input and/or output of most digital peripherals to these I/O pins. PPS is performed in software and generally does not require the device to be reprogrammed. Hardware safeguards are included that prevent accidental or spurious changes to the peripheral mapping once it has been established.

11.3.1 AVAILABLE PINS

The number of available pins is dependent on the particular device and its pin count. Pins that support the PPS feature include the designation "RPn" in their full pin designation, where "RP" designates a remappable peripheral and "n" is the remappable port number.

11.3.2 AVAILABLE PERIPHERALS

The peripherals managed by the PPS are all digitalonly peripherals. These include general serial communications (UART and SPI), general purpose timer clock inputs, timer-related peripherals (input capture and output compare) and interrupt-on-change inputs.

In comparison, some digital-only peripheral modules are never included in the PPS feature. This is because the peripheral's function requires special I/O circuitry on a specific port and cannot be easily connected to multiple pins. These modules include I²C among others. A similar requirement excludes all modules with analog inputs, such as the Analog-to-Digital Converter (ADC).

A key difference between remappable and non-remappable peripherals is that remappable peripherals are not associated with a default I/O pin. The peripheral must always be assigned to a specific I/O pin before it can be used. In contrast, non-remappable peripherals are always available on a default pin, assuming that the peripheral is active and not conflicting with another peripheral.

When a remappable peripheral is active on a given I/O pin, it takes priority over all other digital I/O and digital communication peripherals associated with the pin.

Priority is given regardless of the type of peripheral that is mapped. Remappable peripherals never take priority over any analog functions associated with the pin.

11.3.3 CONTROLLING PERIPHERAL PIN SELECT

PPS features are controlled through two sets of SFRs: one to map peripheral inputs, and one to map outputs. Because they are separately controlled, a particular peripheral's input and output (if the peripheral has both) can be placed on any selectable function pin without constraint.

The association of a peripheral to a peripheral-selectable pin is handled in two different ways, depending on whether an input or output is being mapped.

11.3.4 INPUT MAPPING

The inputs of the PPS options are mapped on the basis of the peripheral. That is, a control register associated with a peripheral dictates the pin it will be mapped to. The [*pin name*]R registers, where [*pin name*] refers to the peripheral pins listed in Table 11-1, are used to configure peripheral input mapping (see Register 11-1). Each register contains sets of 4 bit fields. Programming these bit fields with an appropriate value maps the RPn pin with the corresponding value to that peripheral. For any given device, the valid range of values for any bit field is shown in Table 11-1.

For example, Figure 11-2 illustrates the remappable pin selection for the U1RX input.

FIGURE 11-2: REMAPPABLE INPUT EXAMPLE FOR U1RX



REGIST	ER 17-1: SPIxCON: SPI CONTROL REGISTER (CONTINUED)
bit 17	SPIFE: Frame Sync Pulse Edge Select bit (Framed SPI mode only)
	1 = Frame synchronization pulse coincides with the first bit clock
bit 16	ENHBITE: Enhanced Buffer Enable bit ⁽²⁾
Sit 10	1 = Enhanced Buffer mode is enabled
	0 = Enhanced Buffer mode is disabled
bit 15	ON: SPI Peripheral On bit ⁽¹⁾
	1 = SPI Peripheral is enabled
hit 14	Unimplemented: Read as '0'
bit 13	SIDL: Stop in Idle Mode bit
	1 = Discontinue module operation when the device enters Idle mode
	0 = Continue module operation when the device enters Idle mode
bit 12	DISSDO: Disable SDOx pin bit
	1 = SDOx pin is not used by the module. Pin is controlled by associated PORT register $0 = SDOx pin is controlled by the module$
bit 11-10	MODE<32.16>: 32/16-Bit Communication Select bits
	When AUDEN = 1:
	MODE32 MODE16 Communication
	1 1 24-bit Data, 32-bit FIFO, 32-bit Channel/64-bit Frame
	1 0 32-bit Data, 32-bit FIFO, 32-bit Channel/64-bit Frame
	0 0 16-bit Data, 16-bit FIFO, 16-bit Channel/32-bit Frame
	When AUDEN = 0:
	MODE32 MODE16 Communication
	1 x 32-bit
	0 0 8-bit
bit 9	SMP: SPI Data Input Sample Phase bit
	Master mode (MSTEN = 1):
	 Input data sampled at end of data output time Input data sampled at middle of data output time
	Slave mode (MSTEN = 0):
	SMP value is ignored when SPI is used in Slave mode. The module always uses SMP = 0.
	To write a '1' to this bit, the MSTEN value = 1 must first be written.
bit 8	CKE: SPI Clock Edge Select bit ⁽³⁾
	1 = Serial output data changes on transition from active clock state to Idle clock state (see the CKP bit) 0 = Serial output data changes on transition from Idle clock state to active clock state (see the CKP bit)
bit 7	SSEN: Slave Select Enable (Slave mode) bit
bit i	$1 = \overline{SSx}$ pin used for Slave mode
	$0 = \overline{SSx}$ pin not used for Slave mode, pin controlled by port function.
bit 6	CKP: Clock Polarity Select bit ⁽⁴⁾
	1 = 1 dle state for clock is a high level; active state is a low level 0 = 1 dle state for clock is a low level; active state is a high level
Note 1:	When using the 1:1 PBCLK divisor, the user's software should not read or write the peripheral's SFRs in
	the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
2:	This bit can only be written when the ON bit = 0.
3:	I his bit is not used in the Framed SPI mode. The user should program this bit to '0' for the Framed SPI mode (FRMEN = 1).
4:	When AUDEN = 1, the SPI module functions as if the CKP bit is equal to '1', regardless of the actual value
	of CKP.

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REGISTER 17-2: SPIxCON2: SPI CONTROL REGISTER 2

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24	—	—	—	—	—	—	-	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	—	—	—	—	—	_	—
15.0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
10.0	SPISGNEXT	—	—	FRMERREN	SPIROVEN	SPITUREN	IGNROV	IGNTUR
7:0	R/W-0	U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0
7:0	AUDEN ⁽¹⁾	_	—	—	AUDMONO ^(1,2)	—	AUDMOD)<1:0> ^(1,2)

Legend:

= Readable bit W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-16 Unimplemented: Read as '0'

- bit 15 SPISGNEXT: Sign Extend Read Data from the RX FIFO bit
 - 1 = Data from RX FIFO is sign extended
 - 0 = Data from RX FIFO is not sign extended
- bit 14-13 Unimplemented: Read as '0'
- bit 12 **FRMERREN:** Enable Interrupt Events via FRMERR bit
 - 1 = Frame Error overflow generates error events
 - 0 = Frame Error does not generate error events
- bit 11 SPIROVEN: Enable Interrupt Events via SPIROV bit
 - 1 = Receive overflow generates error events
 - 0 = Receive overflow does not generate error events
- bit 10 SPITUREN: Enable Interrupt Events via SPITUR bit
 - 1 = Transmit underrun generates error events
 - 0 = Transmit underrun does not generate error events
- bit 9 IGNROV: Ignore Receive Overflow bit (for Audio Data Transmissions)
 - 1 = A ROV is not a critical error; during ROV data in the FIFO is not overwritten by receive data
 0 = A ROV is a critical error that stops SPI operation
- bit 8 **IGNTUR:** Ignore Transmit Underrun bit (for Audio Data Transmissions)
 - 1 = A TUR is not a critical error and zeros are transmitted until the SPIxTXB is not empty
 - 0 = A TUR is a critical error that stops SPI operation
- bit 7 AUDEN: Enable Audio CODEC Support bit⁽¹⁾
- 1 = Audio protocol enabled
 - 0 = Audio protocol disabled
- bit 6-5 Unimplemented: Read as '0'
- bit 3 AUDMONO: Transmit Audio Data Format bit^(1,2)
 - 1 = Audio data is mono (Each data word is transmitted on both left and right channels)
 - 0 = Audio data is stereo
- bit 2 Unimplemented: Read as '0'
- bit 1-0 AUDMOD<1:0>: Audio Protocol Mode bit^(1,2)
 - 11 = PCM/DSP mode
 - 10 = Right-Justified mode
 - 01 = Left-Justified mode
 - $00 = I^2S \mod$
- **Note 1:** This bit can only be written when the ON bit = 0.
 - **2:** This bit is only valid for AUDEN = 1.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
04.04	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
31:24		YEAR1	0<3:0>			YEAR0	1<3:0>		
00.40	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
23:16	—	—	—	MONTH10		MONTH	01<3:0>		
45.0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
15:8	_	—	DAY1)<1:0>		DAY01<3:0>			
7.0	U-0	U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	
7:0	—	—	—	—	—	V	VDAY01<2:0	>	
	•								
Legend:									
R = Read	lable bit		W = Writable	e bit	U = Unimple	emented bit, re	ead as '0'		
-n = Value	e at POR		'1' = Bit is se	et	'0' = Bit is cl	eared	x = Bit is un	known	

REGISTER 21-4: RTCDATE: RTC DATE VALUE REGISTER

bit 31-28 YEAR10<3:0>: Binary-Coded Decimal Value of Years bits, 10s place digit; contains a value from 0 to 9

bit 27-24 **YEAR01<3:0>:** Binary-Coded Decimal Value of Years bits, 1s place digit; contains a value from 0 to 9 bit 23-21 **Unimplemented:** Read as '0'

bit 20 **MONTH10:** Binary-Coded Decimal Value of Months bits, 10s place digit; contains a value of 0 or 1

bit 19-16 **MONTH01<3:0>:** Binary-Coded Decimal Value of Months bits, 1s place digit; contains a value from 0 to 9 bit 15-14 **Unimplemented:** Read as '0'

bit 13-12 DAY10<1:0>: Binary-Coded Decimal Value of Days bits, 10s place digit; contains a value of 0 to 3

bit 11-8 DAY01<3:0>: Binary-Coded Decimal Value of Days bits, 1s place digit; contains a value from 0 to 9

bit 7-3 **Unimplemented:** Read as '0'

bit 2-0 WDAY01<2:0>: Binary-Coded Decimal Value of Weekdays bits; contains a value from 0 to 6

Note: This register is only writable when RTCWREN = 1 (RTCCON<3>).

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	—	—	—	—	—	—	—	—
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:10	—	—	—	—	—	—	—	—
45.0	R/W-0	R/W-0	R/W-0	U-0	U-0 U-0		U-0	R-0
15:8	ON ⁽¹⁾	COE	CPOL ⁽²⁾	—	—	—	—	COUT
7.0	R/W-1	R/W-1	U-0	R/W-0	U-0	U-0	R/W-1	R/W-1
7:0	EVPOL	_<1:0>	_	CREF	_	_	CCH	<1:0>

REGISTER 23-1: CMXCON: COMPARATOR CONTROL REGISTER

Legend:

5						
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-16 Unimplemented: Read as '0'

- bit 15 **ON:** Comparator ON bit⁽¹⁾
 - 1 = Module is enabled. Setting this bit does not affect the other bits in this register
 - 0 = Module is disabled and does not consume current. Clearing this bit does not affect the other bits in this register
- bit 14 **COE:** Comparator Output Enable bit
 - 1 = Comparator output is driven on the output CxOUT pin
 - 0 = Comparator output is not driven on the output CxOUT pin
- bit 13 **CPOL:** Comparator Output Inversion bit⁽²⁾
 - 1 = Output is inverted
 - 0 = Output is not inverted
- bit 12-9 Unimplemented: Read as '0'
- bit 8 **COUT:** Comparator Output bit
 - 1 = Output of the Comparator is a '1'
 - 0 = Output of the Comparator is a '0'
- bit 7-6 **EVPOL<1:0>:** Interrupt Event Polarity Select bits
 - 11 = Comparator interrupt is generated on a low-to-high or high-to-low transition of the comparator output
 - 10 = Comparator interrupt is generated on a high-to-low transition of the comparator output
 - 01 = Comparator interrupt is generated on a low-to-high transition of the comparator output
 - 00 = Comparator interrupt generation is disabled
- bit 5 Unimplemented: Read as '0'
- bit 4 CREF: Comparator Positive Input Configure bit
 - 1 = Comparator non-inverting input is connected to the internal CVREF
 - 0 = Comparator non-inverting input is connected to the CXINA pin
- bit 3-2 Unimplemented: Read as '0'
- bit 1-0 CCH<1:0>: Comparator Negative Input Select bits for Comparator
 - 11 = Comparator inverting input is connected to the IVREF
 - 10 = Comparator inverting input is connected to the CxIND pin
 - 01 = Comparator inverting input is connected to the CxINC pin
 - 00 = Comparator inverting input is connected to the CxINB pin
- **Note 1:** When using the 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
 - 2: Setting this bit will invert the signal to the comparator interrupt generator as well. This will result in an interrupt being generated on the opposite edge from the one selected by EVPOL<1:0>.

REGISTER 25-1: CTMUCON: CTMU CONTROL REGISTER (CONTINUED)

- bit 10 EDGSEQEN: Edge Sequence Enable bit 1 = Edge1 must occur before Edge2 can occur 0 = No edge sequence is needed IDISSEN: Analog Current Source Control bit⁽²⁾ bit 9 1 = Analog current source output is grounded 0 = Analog current source output is not grounded bit 8 **CTTRIG:** Trigger Control bit 1 = Trigger output is enabled 0 = Trigger output is disabled bit 7-2 ITRIM<5:0>: Current Source Trim bits 011111 = Maximum positive change from nominal current 011110 000001 = Minimum positive change from nominal current 000000 = Nominal current output specified by IRNG<1:0> 111111 = Minimum negative change from nominal current 100010 100001 = Maximum negative change from nominal current bit 1-0 IRNG<1:0>: Current Range Select bits⁽³⁾ 11 = 100 times base current 10 = 10 times base current
 - 01 = Base current level
 - 00 = 1000 times base current⁽⁴⁾
- Note 1: When this bit is set for Pulse Delay Generation, the EDG2SEL<3:0> bits must be set to '1110' to select C2OUT.
 - 2: The ADC module Sample and Hold capacitor is not automatically discharged between sample/conversion cycles. Software using the ADC as part of a capacitive measurement, must discharge the ADC capacitor before conducting the measurement. The IDISSEN bit, when set to '1', performs this function. The ADC module must be sampling while the IDISSEN bit is active to connect the discharge sink to the capacitor array.
 - Refer to the CTMU Current Source Specifications (Table 30-41) in Section 30.0 "Electrical 3: Characteristics" for current values.
 - 4: This bit setting is not available for the CTMU temperature diode.

REGISTER 27-2: DEVCFG1: DEVICE CONFIGURATION WORD 1 (CONTINUED)

bit 15-14 FCKSM<1:0>: Clock Switching and Monitor Selection Configuration bits

- 1x = Clock switching is disabled, Fail-Safe Clock Monitor is disabled
- 01 = Clock switching is enabled, Fail-Safe Clock Monitor is disabled
- 00 = Clock switching is enabled, Fail-Safe Clock Monitor is enabled
- bit 13-12 FPBDIV<1:0>: Peripheral Bus Clock Divisor Default Value bits
 - 11 = PBCLK is SYSCLK divided by 8
 - 10 = PBCLK is SYSCLK divided by 4
 - 01 = PBCLK is SYSCLK divided by 2
 - 00 = PBCLK is SYSCLK divided by 1
- bit 11 Reserved: Write '1'
- bit 10 OSCIOFNC: CLKO Enable Configuration bit
 - 1 = CLKO output disabled
 - 0 = CLKO output signal active on the OSCO pin; Primary Oscillator must be disabled or configured for the External Clock mode (EC) for the CLKO to be active (POSCMOD<1:0> = 11 or 00)

bit 9-8 **POSCMOD<1:0>:** Primary Oscillator Configuration bits

- 11 = Primary Oscillator is disabled
- 10 = HS Oscillator mode is selected
- 01 = XT Oscillator mode is selected
- 00 = External Clock mode is selected
- bit 7 IESO: Internal External Switchover bit
 - 1 = Internal External Switchover mode is enabled (Two-Speed Start-up is enabled)
 - 0 = Internal External Switchover mode is disabled (Two-Speed Start-up is disabled)
- bit 6 **Reserved:** Write '1'
- bit 5 **FSOSCEN:** Secondary Oscillator Enable bit
 - 1 = Enable Secondary Oscillator
 - 0 = Disable Secondary Oscillator
- bit 4-3 Reserved: Write '1'
- bit 2-0 **FNOSC<2:0>:** Oscillator Selection bits
 - 111 = Fast RC Oscillator with divide-by-N (FRCDIV)
 - 110 = FRCDIV16 Fast RC Oscillator with fixed divide-by-16 postscaler
 - 101 = Low-Power RC Oscillator (LPRC)
 - 100 = Secondary Oscillator (Sosc)
 - 011 = Primary Oscillator (Posc) with PLL module (XT+PLL, HS+PLL, EC+PLL)
 - 010 = Primary Oscillator (XT, HS, EC)⁽¹⁾
 - 001 = Fast RC Oscillator with divide-by-N with PLL module (FRCDIV+PLL)
 - 000 = Fast RC Oscillator (FRC)
- **Note 1:** Do not disable the Posc (POSCMOD = 11) when using this oscillator source.

29.11 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM[™] and dsPICDEM[™] demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ[®] security ICs, CAN, IrDA[®], PowerSmart battery management, SEEVAL[®] evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

29.12 Third-Party Development Tools

Microchip also offers a great collection of tools from third-party vendors. These tools are carefully selected to offer good value and unique functionality.

- Device Programmers and Gang Programmers from companies, such as SoftLog and CCS
- Software Tools from companies, such as Gimpel and Trace Systems
- Protocol Analyzers from companies, such as Saleae and Total Phase
- Demonstration Boards from companies, such as MikroElektronika, Digilent[®] and Olimex
- Embedded Ethernet Solutions from companies, such as EZ Web Lynx, WIZnet and IPLogika[®]

30.1 DC Characteristics

TABLE 30-1: OPERATING MIPS VS. VOLTAGE

Characteristic	VDD Range	Temp. Range	Max. Frequency		
Characteristic	(in Volts) ⁽¹⁾	(in °C)	PIC32MX1XX/2XX 28/36/44-pin Family		
DC5	2.3-3.6V	-40°C to +85°C	40 MHz		
DC5b	2.3-3.6V	-40°C to +105°C	40 MHz		

Note 1: Overall functional device operation at VBORMIN < VDD < VDDMIN is tested, but not characterized. All device Analog modules, such as ADC, etc., will function, but with degraded performance below VDDMIN. Refer to parameter BO10 in Table 30-11 for BOR values.

TABLE 30-2: THERMAL OPERATING CONDITIONS

Rating	Symbol	Min.	Typical	Max.	Unit
Industrial Temperature Devices					
Operating Junction Temperature Range	TJ	-40	—	+125	°C
Operating Ambient Temperature Range	TA	-40	—	+85	°C
V-temp Temperature Devices					
Operating Junction Temperature Range	TJ	-40	_	+140	°C
Operating Ambient Temperature Range	TA	TA -40 — +105			
Power Dissipation: Internal Chip Power Dissipation: PINT = VDD x (IDD – S IOH)	PD	PINT + PI/O			W
I/O Pin Power Dissipation: I/O = S (({VDD – VOH} x IOH) + S (VOL x IOL))					
Maximum Allowed Power Dissipation	PDMAX	(TJ — TA)/θJ	A	W

TABLE 30-3: THERMAL PACKAGING CHARACTERISTICS

Characteristics	Symbol	Typical	Max.	Unit	Notes
Package Thermal Resistance, 28-pin SSOP	θJA	71	_	°C/W	1
Package Thermal Resistance, 28-pin SOIC	θJA	50	_	°C/W	1
Package Thermal Resistance, 28-pin SPDIP	θJA	42		°C/W	1
Package Thermal Resistance, 28-pin QFN	θJA	35		°C/W	1
Package Thermal Resistance, 36-pin VTLA	θJA	31	—	°C/W	1
Package Thermal Resistance, 44-pin QFN	θJA	32		°C/W	1
Package Thermal Resistance, 44-pin TQFP	θJA	45		°C/W	1
Package Thermal Resistance, 44-pin VTLA	θJA	30	—	°C/W	1

Note 1: Junction to ambient thermal resistance, Theta-JA (θ JA) numbers are achieved by package simulations.



TABLE 30-23: TIMER1 EXTERNAL CLOCK TIMING REQUIREMENTS

AC CHARACTERISTICS ⁽¹⁾ Sta Opt				Star (un Ope	Standard Operating Conditions: 2.3V to 3.6V(unless otherwise stated)Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +105^{\circ}C$ for V-temp				
Param. No.	Symbol	Charac	teristics ⁽²⁾		Min.	Typical	Max.	Units	Conditions
TA10	Т⊤хН	TxCK High Time	Synchrono with presc	ous, aler	[(12.5 ns or 1 TPB)/N] + 25 ns	—	—	ns	Must also meet parameter TA15
			Asynchror with presc	nous, aler	10	—		ns	—
TA11	ΤτxL	TxCK Low Time	Synchrono with presc	ous, aler	[(12.5 ns or 1 ТРв)/N] + 25 ns	—		ns	Must also meet parameter TA15
			Asynchronous, with prescaler		10	—		ns	—
TA15	ΤτχΡ	TxCK Input Period	Synchronous, with prescaler		[(Greater of 25 ns or 2 TPB)/N] + 30 ns	-	_	ns	VDD > 2.7V
					[(Greater of 25 ns or 2 TPB)/N] + 50 ns	—	_	ns	VDD < 2.7V
			Asynchror with presc	nous, aler	20	-	_	ns	VDD > 2.7V (Note 3)
					50	-	_	ns	VDD < 2.7V (Note 3)
OS60	FT1	SOSC1/T1C Input Freque (oscillator en the TCS (T1	SOSC1/T1CK Oscillator Input Frequency Range (oscillator enabled by setti the TCS (T1CON<1>) bit		32	_	100	kHz	_
TA20	TCKEXTMRL	Delay from External TxCK Clock Edge to Timer Increment		СК	_	_	1	Трв	_

Note 1: Timer1 is a Type A timer.

2: This parameter is characterized, but not tested in manufacturing.

3: N = Prescale Value (1, 8, 64, 256).

31.0 50 MHz ELECTRICAL CHARACTERISTICS

This section provides an overview of the PIC32MX1XX/2XX 28/36/44-pin Family electrical characteristics for devices operating at 50 MHz.

The specifications for 50 MHz are identical to those shown in **Section 30.0** "Electrical Characteristics", with the exception of the parameters listed in this chapter.

Parameters in this chapter begin with the letter "M", which denotes 50 MHz operation. For example, parameter DC29a in **Section 30.0** "**Electrical Characteristics**", is the up to 40 MHz operation equivalent for MDC29a.

Absolute maximum ratings for the PIC32MX1XX/2XX 28/36/44-pin Family 50 MHz devices are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these or any other conditions, above the parameters indicated in the operation listings of this specification, is not implied.

Absolute Maximum Ratings

(See Note 1)

Ambient temperature under bias	40°C to +85°C
Storage temperature	65°C to +150°C
Voltage on VDD with respect to Vss	-0.3V to +4.0V
Voltage on any pin that is not 5V tolerant, with respect to Vss (Note 3)	0.3V to (VDD + 0.3V)
Voltage on any 5V tolerant pin with respect to Vss when $VDD \ge 2.3V$ (Note 3)	-0.3V to +5.5V
Voltage on any 5V tolerant pin with respect to Vss when VDD < 2.3V (Note 3)	-0.3V to +3.6V
Voltage on D+ or D- pin with respect to VUSB3V3	0.3V to (VUSB3V3 + 0.3V)
Voltage on VBUS with respect to VSS	-0.3V to +5.5V
Maximum current out of Vss pin(s)	
Maximum current into VDD pin(s) (Note 2)	
Maximum output current sunk by any I/O pin	15 mA
Maximum output current sourced by any I/O pin	15 mA
Maximum current sunk by all ports	
Maximum current sourced by all ports (Note 2)	200 mA

Note 1: Stresses above those listed under "**Absolute Maximum Ratings**" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions, above those indicated in the operation listings of this specification, is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

- 2: Maximum allowable current is a function of device maximum power dissipation (see Table 30-2).
- 3: See the "Pin Diagrams" section for the 5V tolerant pins.